



3.8x2.0mm DOME LENS SMD CHIP LED LAMP



Features

• Ideal for indication light on hand held products

• Long life and robust package

• Standard Package: 500pcs/ Reel

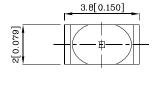
 \bullet MSL (Moisture Sensitivity Level): 3

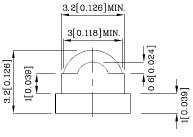
• RoHS compliant

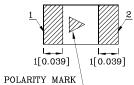




Package Schematics







Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted. 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)	M2MOK (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V
Forward Current	I_{F}	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA
Power Dissipation	P_{D}	84	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

Operating Characteristics (T _A =25°C)	M2MOK (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.2	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.8	V
Reverse Current (Max.) (V _R =5V)	I_R	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λР	611*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=20\text{mA})$	λD	605*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$\triangle \lambda$	17	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	27	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 2θ 1/2
				min.	typ.		
ZM2MOK79W	Orange	AlGaInP	Water Clear	3600 1300*	4790 1495*	611*	60°(H) 35°(V)

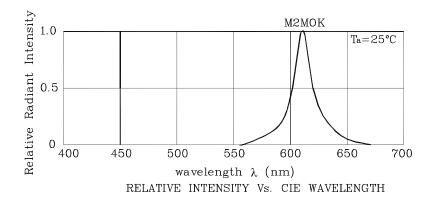
^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

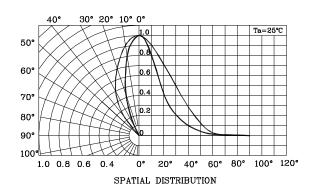
Feb 18,2014

SDSA9353 V1-X Layout: Maggie L.

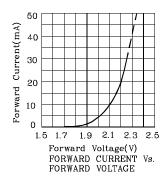


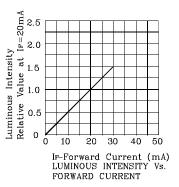


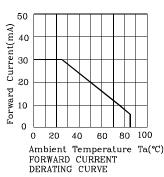


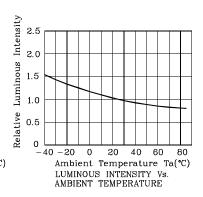


❖ M2MOK



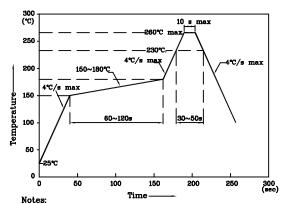






LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

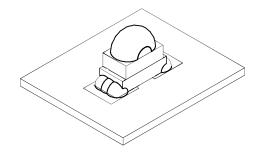


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

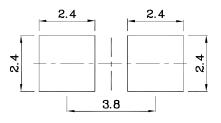




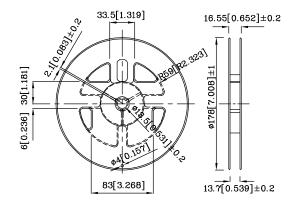
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



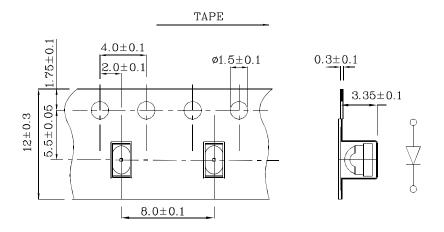
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

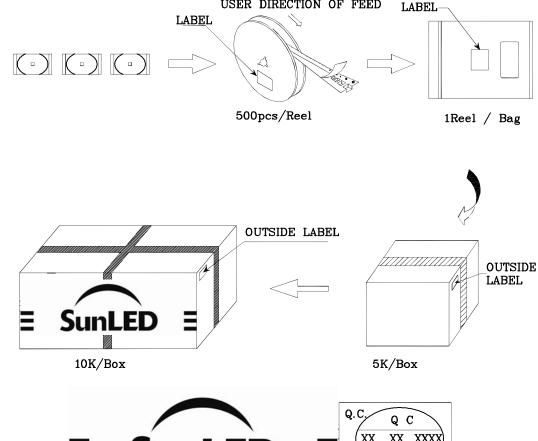
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

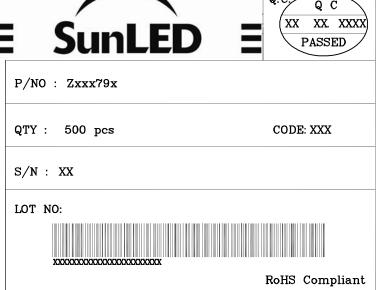




PACKING & LABEL SPECIFICATIONS



USER DIRECTION OF FEED



TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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